

**INTEGRATED CIRCUITS**

# DATA SHEET

## **TDA4557** Multistandard decoder

Product specification  
File under Integrated Circuits, IC02

March 1991

## Multistandard decoder

## TDA4557

### GENERAL DESCRIPTION

The TDA4557 is a monolithic integrated multistandard colour decoder for the PAL, SECAM, NTSC 3.58 MHz and NTSC 4.43 MHz standards.

### FEATURES

#### Chrominance part

- Gain controlled chrominance amplifier for PAL, SECAM and NTSC
- ACC rectifier circuits (PAL/NTSC, SECAM)
- Burst blanking (PAL) in front of 64  $\mu$ s glass delay line
- Chrominance output stage for driving the 64  $\mu$ s glass delay line (PAL, SECAM)
- Limiter stages for direct and delayed SECAM signal
- SECAM permutator

#### Demodulator part

- Flyback blanking incorporated in the demodulators (PAL, NTSC, SECAM)
- PAL switch
- Internal PAL matrix

- Two quadrature demodulators with external reference tuned circuits (SECAM)
- Internal filtering of residual carrier
- De-emphasis (SECAM)

#### Identification part

- Automatic standard recognition by sequential inquiry
- Delay for colour-on and scanning-on
- Reliable SECAM identification by PAL priority circuit and 50/60 Hz recognition
- Forced switch-on of a standard
- Four switching voltages for chrominance filters, traps and crystals
- Two identification circuits for PAL/SECAM (H/2) and NTSC
- PAL/SECAM flip-flop
- SECAM identification mode switch (horizontal, vertical or combined horizontal and vertical)
- Crystal oscillator with divider stages and PLL circuitry (PAL, NTSC) for double colour subcarrier frequency
- HUE control (NTSC)
- Service switch

### QUICK REFERENCE DATA

PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT
Supply voltage (pin 13)	$V_P$	10.8	12.0	13.2	V
Supply current (pin 13)	$I_P$	—	65	—	mA
Chrominance input voltage (peak-to-peak value)	$V_{15(p-p)}$	20	100	400	mV
Chrominance output voltage (peak-to-peak value)	$V_{12(p-p)}$	—	1.6	—	V
Colour difference output voltages (peak-to-peak values)					
—(R-Y)	$V_{1(p-p)}$	—	$1.05 \text{ V} \pm 2 \text{ dB}$	—	V
—(B-Y)	$V_{3(p-p)}$	—	$1.33 \text{ V} \pm 2 \text{ dB}$	—	V
Sandcastle pulse (pin 24)					
Required amplitude to separate vertical and horizontal pulse	$V_{24(p-p)}$	2.0	2.5	3.0	V
horizontal pulse	$V_{24(p-p)}$	4.1	4.5	4.9	V
burst gating pulse	$V_{24(p-p)}$	7.7	—	$V_P$	V

### PACKAGE OUTLINE

28-lead DIL; plastic (SOT117); SOT117-1; 1996 November 27.

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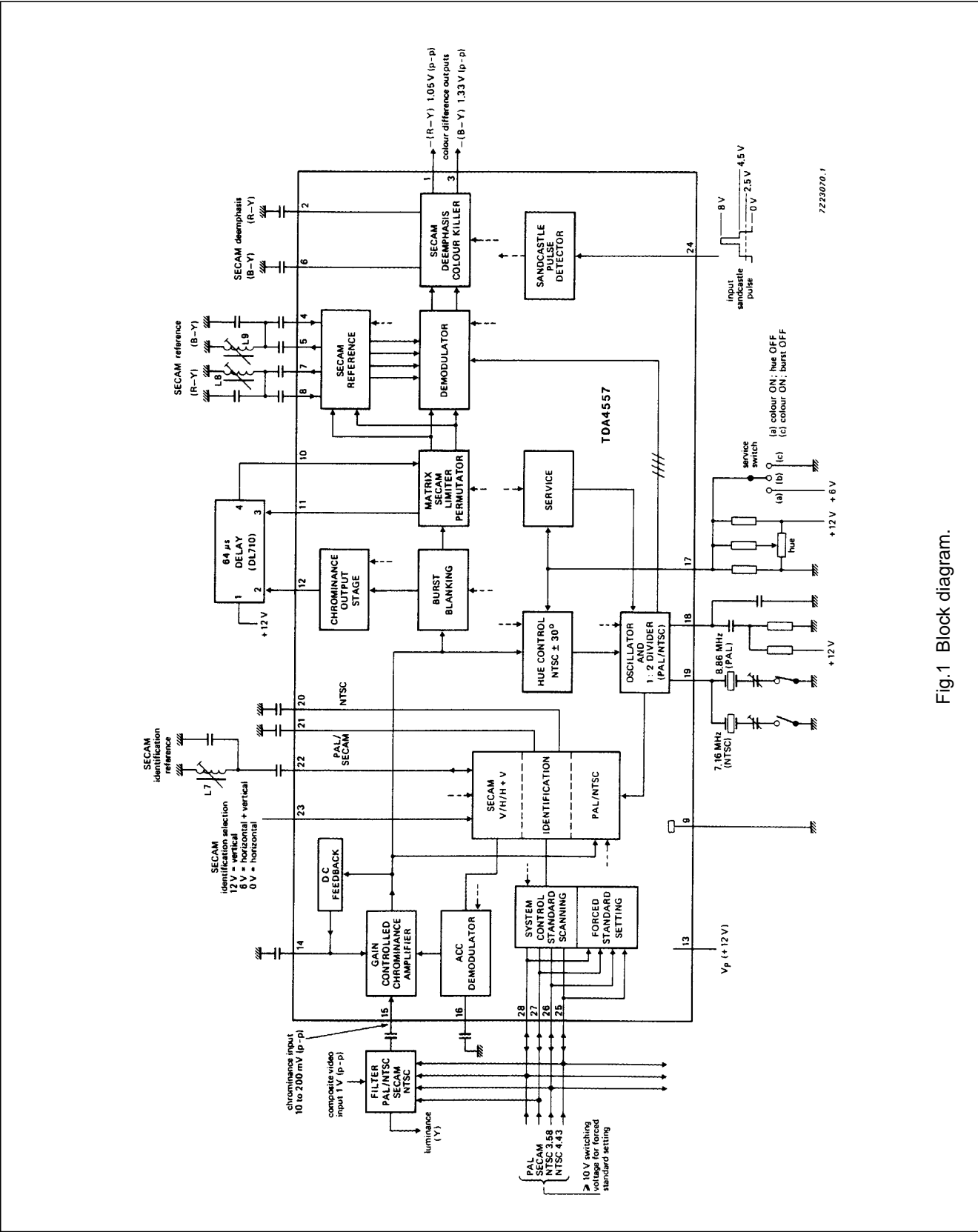


Fig.1 Block diagram.

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**RATINGS**

Limiting values in accordance with the Absolute Maximum System (IEC 134)

PARAMETER	SYMBOL	MIN.	MAX.	UNIT
Supply voltage (pin 13)	$V_P$	—	13.2	V
Voltage range at pins 10, 11, 17, 23, 24, 25, 26, 27, 28 to pin 9 (ground)	$V_{n-9}$	0	$V_P$	V
Current at pin 12	$I_{12}$	—	8	mA
Peak value	$I_{12M}$	—	15	mA
Total power dissipation	$P_{tot}$	—	1.4	W
Storage temperature range	$T_{stg}$	−25	+ 150	°C
Operating ambient temperature range	$T_{amb}$	0	+ 70	°C

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## CHARACTERISTICS

$V_P = V_{13-9} = 12\text{ V}$ ;  $T_{\text{amb}} = 25\text{ }^{\circ}\text{C}$ ; measured in Fig.1; unless otherwise specified

PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT
<b>Supply (pin 13)</b>					
Supply voltage range	$V_P$	10.8	1.2	13.2	V
Supply current	$I_P$	50	65	80	mA
<b>Chrominance part</b>					
Chrominance input signal (pin 15)					
input voltage with 75% colour bar signal (peak-to-peak value)	$V_{15(p-p)}$	20	100	400	mV
input impedance	$ Z_{15-9} $	7	10	—	k $\Omega$
Chrominance output signal (pin 12)					
output voltage (peak-to-peak value)	$V_{12(p-p)}$	1.1	1.6	1.75	V
output impedance (npn emitter follower)	$ Z_{12-9} $	—	—	20	$\Omega$
DC output voltage	$V_{12-9}$	7.3	8.2	9.0	V
Input for delayed signal (pin 10)					
DC input current	$I_{10}$	—	—	10	$\mu\text{A}$
input resistance	$R_{10-9}$	10	—	—	k $\Omega$
<b>Demodulator part (PAL/NTSC)</b>					
Colour difference output signals					
output voltage (proportional to $V_{13-9}$ ) (peak-to-peak value)					
— (R-Y) signal (pin 1)	$V_{1(p-p)}$	—	$1.05\text{ V} \pm 2\text{ dB}$	—	V
— (B-Y) signal (pin 3)	$V_{3(p-p)}$	—	$1.33\text{ V} \pm 2\text{ dB}$	—	V
Ratio of colour difference output signals (R-Y)/(B-Y)	$V_{1/3-9}$	—	$0.79 \pm 10\%$	—	
Residual carrier (subcarrier frequency) (peak-to-peak value)	$V_{1,3(p-p)}$	—	—	30	mV
Residual carrier (PAL only) (peak-to-peak value)	$V_{1,3(p-p)}$	—	10	—	mV
H/2 ripple at (R-Y) output (pin 1) (peak-to-peak value) without input signal	$V_{1(p-p)}$	—	—	10	mV
DC output voltage					
nnp emitter follower with internal current source of 0.3 mA	$V_{1,3-9}$	7.0	7.7	8.4	V
output impedance	$ Z_{1,3-9} $	—	—	150	$\Omega$

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PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT
<b>Demodulator part (SECAM)</b>					
Colour difference signals (see note 3)					
output voltage (proportional to $V_{13-9}$ )					
(peak-to-peak value)					
–(R-Y) signal (pin 1)	$V_{1(p-p)}$	–	1.05	–	V
–(B-Y) signal (pin 3)	$V_{3(p-p)}$	–	1.33	–	V
Ratio of colour difference output signals					
(R-Y)/(B-Y)	$V_{1/3-9}$	–	$0.79^{(1)} \pm 10\%$	–	
Residual carrier (4 to 5 MHz)					
(peak-to-peak value)	$V_{1,3(p-p)}$	–	20	30	mV
Residual carrier (8 to 10 MHz)					
(peak-to-peak value)	$V_{1,3(p-p)}$	–	20	30	mV
H/2 ripple					
at (R-Y) (B-Y) outputs (pins 1 and 3)					
(peak-to-peak value)					
with $f_o$ signals	$V_{1,3(p-p)}$	–	–	30	mV
DC output voltage	$V_{1,3-9}$	7.0	7.7	8.4	V
Shift of inserted levels relative to levels					
of demodulated $f_o$ frequencies (IC only)	$\Delta V/\Delta T(R-Y)$	–	0.5	0.6	mV/K
	$\Delta V/\Delta V_P$	–	8	–	mV/V
<b>HUE control (NTSC)/service switch</b>					
Phase shift of reference carrier					
at $V_{17-9} = 2$ V	$-\phi$	30	40	–	deg
at $V_{17-9} = 3$ V	$\phi$	–	0	–	deg
at $V_{17-9} = 4$ V	$+\phi$	30	40	–	deg
Input resistance	$R_{17-9}$	–	5	–	k $\Omega$
Service position					
Switching voltage (pin 17)					
burst OFF; colour ON					
(for oscillator adjustment)	$V_{17-9}$	0	–	0.5	V
HUE control OFF; colour ON					
(for forced colour ON)	$V_{17-9}$	6	–	$V_P$	V
<b>Crystal oscillator (pin 19)</b>					
For double colour subcarrier frequency					
input resistance	$R_{19-9}$	–	350	–	$\Omega$
lock-in-range					
referred to subcarrier frequency	$\Delta f$	$\pm 400$	–	–	Hz

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PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT
<b>Identification part</b>					
Switching voltages for chrominance filters and crystals					
at pin 28 (PAL)					
at pin 27 (SECAM)					
at pin 26 (NTSC 3.58 MHz)					
at pin 25 (NTSC 4.43 MHz)					
Control voltage OFF state	$V_{25,26,27,28-9}$	—	—	0.5	V
Control voltage ON state					
during scanning; colour OFF	$V_{25,26,27,28-9}$	2.1	2.45	2.7	V
colour ON	$V_{25,26,27,28-9}$	5.5	5.8	6.2	V
Output current	$-I_{25,26,27,28-9}$	—	—	3	mA
Voltage for forced switching ON					
PAL	$V_{28-9}$	9	—	$V_P$	V
SECAM	$V_{27-9}$	9	—	$V_P$	V
NTSC 3.58 MHz	$V_{26-9}$	9	—	$V_P$	V
NTSC 4.43 MHz	$V_{25-9}$	9	—	$V_P$	V
Delay time for					
restart of scanning	$t_{dS}$		2 to 3 vertical periods		
colour ON	$t_{dC1}$		2 to 3 vertical periods		
colour OFF	$t_{dC2}$		0 to 1 vertical periods		
SECAM identification (pin 23)					
Input voltage for					
horizontal identification (H)	$V_{23-9}$	0	—	2	V
vertical identification (V)	$V_{23-9}$	10	—	$V_P$	V
combined (H) and (V) identification	$V_{23-9}$	—	6 (note 2)	—	V
Sequence of standard inquiry					
PAL-SECAM-NTSC 3.58 MHz-NTSC 4.43 MHz					
Reliable SECAM identification by PAL priority circuit					
Scanning time for each standard	$t_S$		4 vertical periods		

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PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT
<b>Sandcastle pulse detector</b> (see note 4)					
Input voltage pulse levels (pin 24)					
to separate vertical and horizontal blanking pulses	$V_{24-9}$	1.3	1.6	1.9	V
required pulse amplitude	$V_{24(p-p)}$	2.0	2.5	3.0	V
to separate horizontal blanking pulse	$V_{24-9}$	3.3	3.6	3.9	V
required pulse amplitude	$V_{24(p-p)}$	4.1	4.5	4.9	V
to separate burst gating pulse	$V_{24-9}$	6.6	7.1	7.6	V
required pulse amplitude	$V_{24(p-p)}$	7.7	—	$V_P$	V
Input voltage during horizontal scanning	$V_{24-9}$	—	—	1.0	V
Input current	$-I_{24}$	—	—	100	$\mu A$

**Notes**

1. Value measured without influence of external circuitry.
2. Or not connected.
3. The signal amplitude of the colour difference signals (R-Y) and (B-Y) is dependent on the characteristics of the external tuned circuits at pins 7, 8 and 4, 5 respectively. Adjustment of the amplitude is achieved by varying the Q-factor of these tuned circuits. The resonant frequency must be adjusted such that the demodulated output frequency ( $f_o$ ) provides the same output level as the internally inserted reference voltage (achromatic value).
4. The sandcastle pulse is compared with three internal threshold levels, which are proportional to the supply voltage.



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APPLICATION INFORMATION

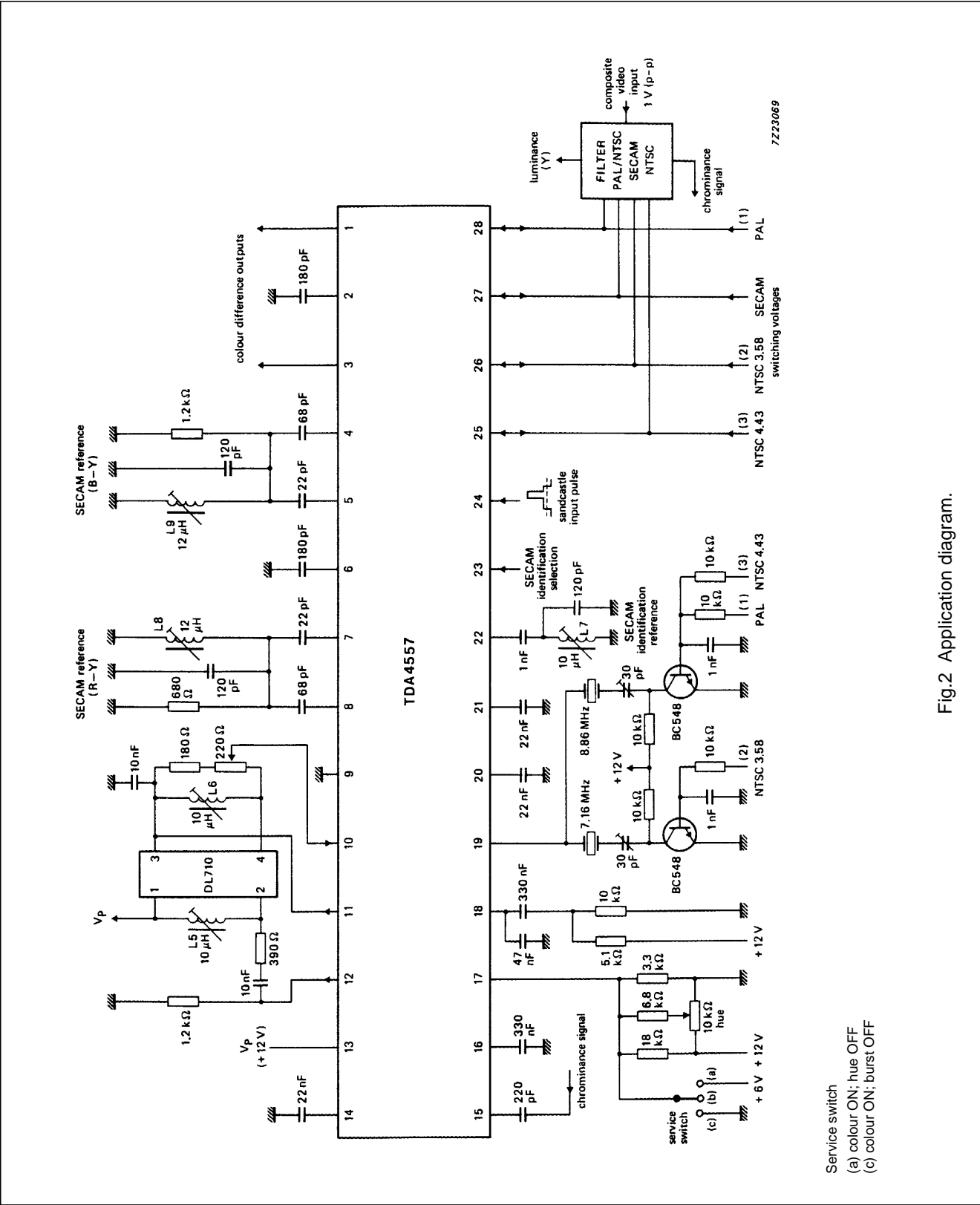


Fig.2 Application diagram.

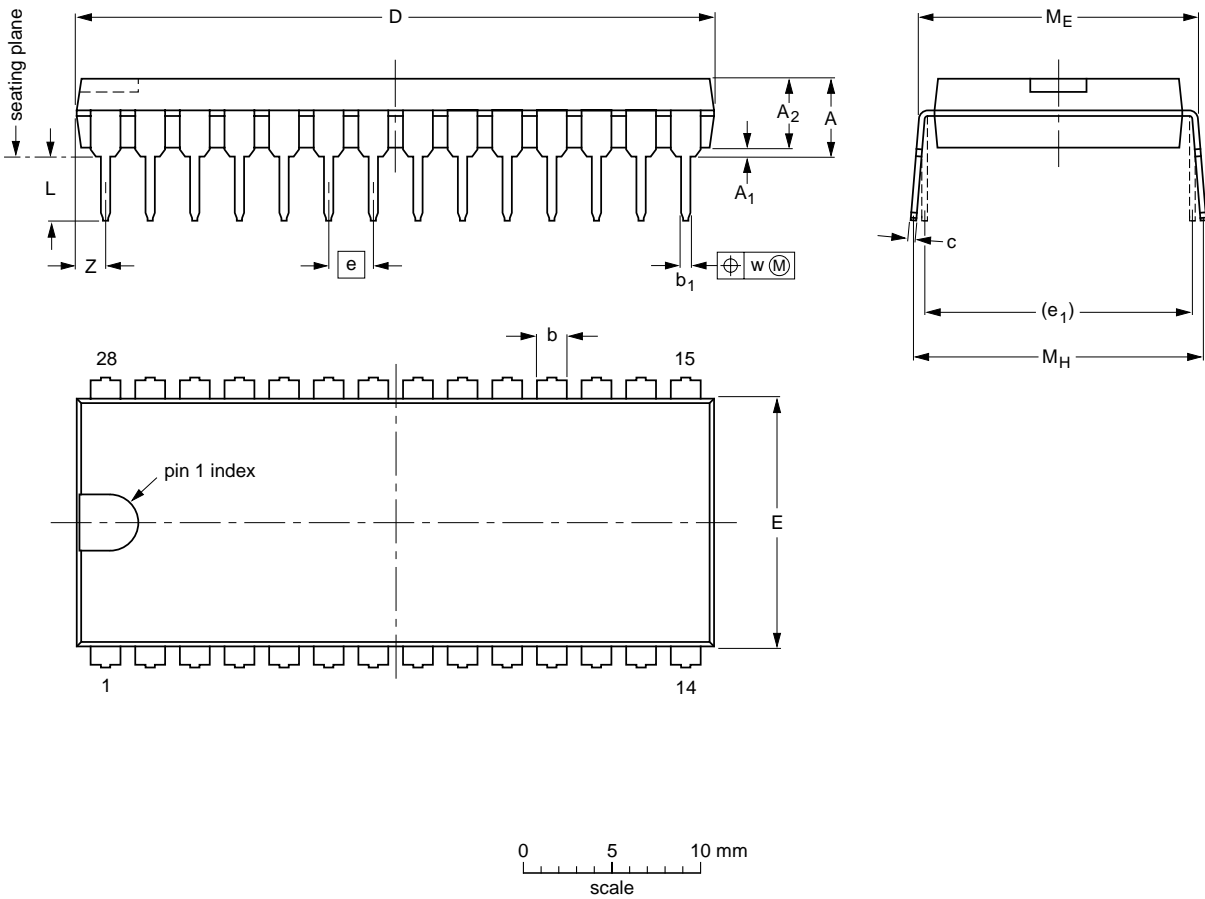
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PACKAGE OUTLINE

DIP28: plastic dual in-line package; 28 leads (600 mil)

SOT117-1



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A <sub>1</sub> min.	A <sub>2</sub> max.	b	b <sub>1</sub>	c	D <sup>(1)</sup>	E <sup>(1)</sup>	e	e <sub>1</sub>	L	M <sub>E</sub>	M <sub>H</sub>	w	Z <sup>(1)</sup> max.
mm	5.1	0.51	4.0	1.7 1.3	0.53 0.38	0.32 0.23	36.0 35.0	14.1 13.7	2.54	15.24	3.9 3.4	15.80 15.24	17.15 15.90	0.25	1.7
inches	0.20	0.020	0.16	0.066 0.051	0.020 0.014	0.013 0.009	1.41 1.34	0.56 0.54	0.10	0.60	0.15 0.13	0.62 0.60	0.68 0.63	0.01	0.067

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT117-1	051G05	MO-015AH				92-11-17- 95-01-14

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**SOLDERING****Introduction**

There is no soldering method that is ideal for all IC packages. Wave soldering is often preferred when through-hole and surface mounted components are mixed on one printed-circuit board. However, wave soldering is not always suitable for surface mounted ICs, or for printed-circuits with high population densities. In these situations reflow soldering is often used.

This text gives a very brief insight to a complex technology. A more in-depth account of soldering ICs can be found in our *"IC Package Databook"* (order code 9398 652 90011).

**Soldering by dipping or by wave**

The maximum permissible temperature of the solder is 260 °C; solder at this temperature must not be in contact with the joint for more than 5 seconds. The total contact time of successive solder waves must not exceed 5 seconds.

The device may be mounted up to the seating plane, but the temperature of the plastic body must not exceed the specified maximum storage temperature ( $T_{stg\ max}$ ). If the printed-circuit board has been pre-heated, forced cooling may be necessary immediately after soldering to keep the temperature within the permissible limit.

**Repairing soldered joints**

Apply a low voltage soldering iron (less than 24 V) to the lead(s) of the package, below the seating plane or not more than 2 mm above it. If the temperature of the soldering iron bit is less than 300 °C it may remain in contact for up to 10 seconds. If the bit temperature is between 300 and 400 °C, contact may be up to 5 seconds.

**DEFINITIONS**

<b>Data sheet status</b>	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
<b>Limiting values</b>	
Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.	
<b>Application information</b>	
Where application information is given, it is advisory and does not form part of the specification.	

**LIFE SUPPORT APPLICATIONS**

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